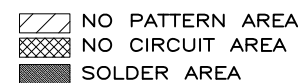


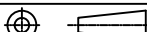
1. 肩?薯P Insertion Force):2.0Kgf Max
2. 拔出力 (Withdrawal Force):0.1Kgf Min
3. 耐久性 (Durability):5000次

1. 额定电流 (Current rating): 1.0A AC/DC
2. 接触电阻 (Contact resistance): 100mΩ MAX
3. 绝缘电阻 (Insulation resistance): 500MΩ MIN
4. 适用温度 (Operating temperature): -20℃~65℃

PIN NO.	PIN ASSIGNMENT
T1	DAT2
T2	CD/DAT3 ²
T3	CMD
T4	VDD
T5	CLK
T6	VSS
T7	DAT0
T8	DAT1



P.C.B LAYOUT
(TOLERANCE $\pm$ 0.05)

 深圳市华宇创精密电子有限公司				
TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X° ±2° X.X° ±0.5°		DRAWN BY : 陈一鸣 DATE : 2014-02-23 PART NAME: MICRO SIM+TF 二合一卡座 H2.3全贴		
 UNIT: mm [inch]		CHECKED BY: 马跃 DATE : 2014-02-23		PART NO. HYCW68-2IN117-230B
		APPROVED BY: 邱敏 DATE : 2014-02-23		MOLD NO.
SCALE:1:1 SIZE: A4		DRAW NO: HYC-2109020951 SHEET NO. 1 OF 1		